Electronic Acknowledgement Receipt					
EFS ID:	3465675				
Application Number:	10666399				
International Application Number:					
Confirmation Number:	8955				
Title of Invention:	Molded chip fabrication method and apparatus				
First Named Inventor/Applicant Name:	Michael S. Leung				
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Filer:	Brian J. Philpott/Eleanor Nakada				
Filer Authorized By:	Brian J. Philpott				
Attorney Docket Number:	P0298US-7				
Receipt Date:	16-JUN-2008				
Filing Date:	18-SEP-2003				
Time Stamp:	20:42:14				
Application Type:	Utility under 35 USC 111(a)				
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# File Listing:

Document Number	Document Description	File Name	File Size(Bytes) /Message Digest	Multi Part /.zip	Pages (if appl.)		
1 Miscellaneous Incoming Letter	Missellaneous Incoming Letter	DOOOLIS 7TmHCorm adf	57163				
	P0298US-7TmtlForm.pdf	c84f2e96f945ba48b09c63e7face0f086 66669df	no	1			
Warnings:	<u> </u>						
Information:							
2 Extension of Time	ExtOneMonth.pdf	59065	no	1			
		7dccb4e359d2e0750fb916770fa927d3 049ed201					
Warnings:							
Information:							
Response to Election / Restriction	RespRestReq.pdf	18723	no	1			
ŭ	Filed	nesphesineq.pui	4b9etc4dtcfet32739ee21d030c2t60b9a 99710b		' 		
Warnings:							
Information:							
4 Claims	Claims.pdf	352622	no	10			
		Giaime.pai	3048424085ffa41e61db0855cb3d408e 5eeba058				
Warnings:							
Information:							
Applicant Arguments/Remarks Made in an Amendment	Remarks-Arguments.pdf	40297	no	2			
		e7d6d6289535815b493c10ec8e26191f edc19d4a					
Warnings:							
Information:			,				
6 Fee Worksheet (PTO-06)	fee-info.pdf	8311	no	2			
		21cf1cb4a1120a6478106575dd83f550f 525027f					
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If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

## National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.

### New International Application Filed with the USPTO as a Receiving Office

If a new international application is being filed and the international application includes the necessary components for an international filing date (see PCT Article 11 and MPEP 1810), a Notification of the International Application Number and of the International Filing Date (Form PCT/RO/105) will be issued in due course, subject to prescriptions concerning national security, and the date shown on this Acknowledgement Receipt will establish the international filing date of the application.